PCA9539

Low-voltage 16-bit I²C and SMBus low-power I/O expander with interrupt output, reset pin and configuration registers

Rev. 1.1 — 1 August 2024 Product data sheet

1. General description

The PCA9539 provides 16 bits of General Purpose Input/Output (GPIO) expansion with interrupt and reset for I²C-bus/SMBus applications. It is designed for a wide voltage range of 2.3 V to 5.5 V. Nexperia GPIO expanders provide an elegant solution when additional IOs are needed while keeping the interconnections to a minimum, for example, in ACPI power switches, sensors, push buttons, LEDs and fan control. The PCA9539 contains a set of 8 bit Input, Output, Configuration and Polarity Inversion registers. At power up all IOs default to inputs. Each IO can be configured as either input or output by changing the corresponding bit in the configuration register. The data for each input or output is stored in the corresponding input or output register. The polarity inversion register can be programmed to invert the polarity of the read register. The PCA9539 has an open-drain interrupt output which is activated when any one of the GPIO changes from its corresponding input port register state. $\overline{INT}$ can be connected to the interrupt input of a microcontroller. By sending an interrupt signal on this line, the remote I/O can inform the microcontroller if there is incoming data on its ports without having to communicate via the I²C-bus. Thus, PCA9539 can remain a simple slave. The power on reset sets the registers to default values and initializes the device state machine. The $\overline{RESET}$ pin can be used to achieve same reset functionality without power down/up cycling by keeping active low. The state machine and the registers are in their default state until the $\overline{RESET}$ input is once again HIGH. This input requires pull up to V_{CC}. The PCA9539 has two address pins A0 and A1 which can be used to configure the I²C bus slave address of the device. It allows up-to four devices to share the same I²C-bus/SMBus.

2. Features and benefits

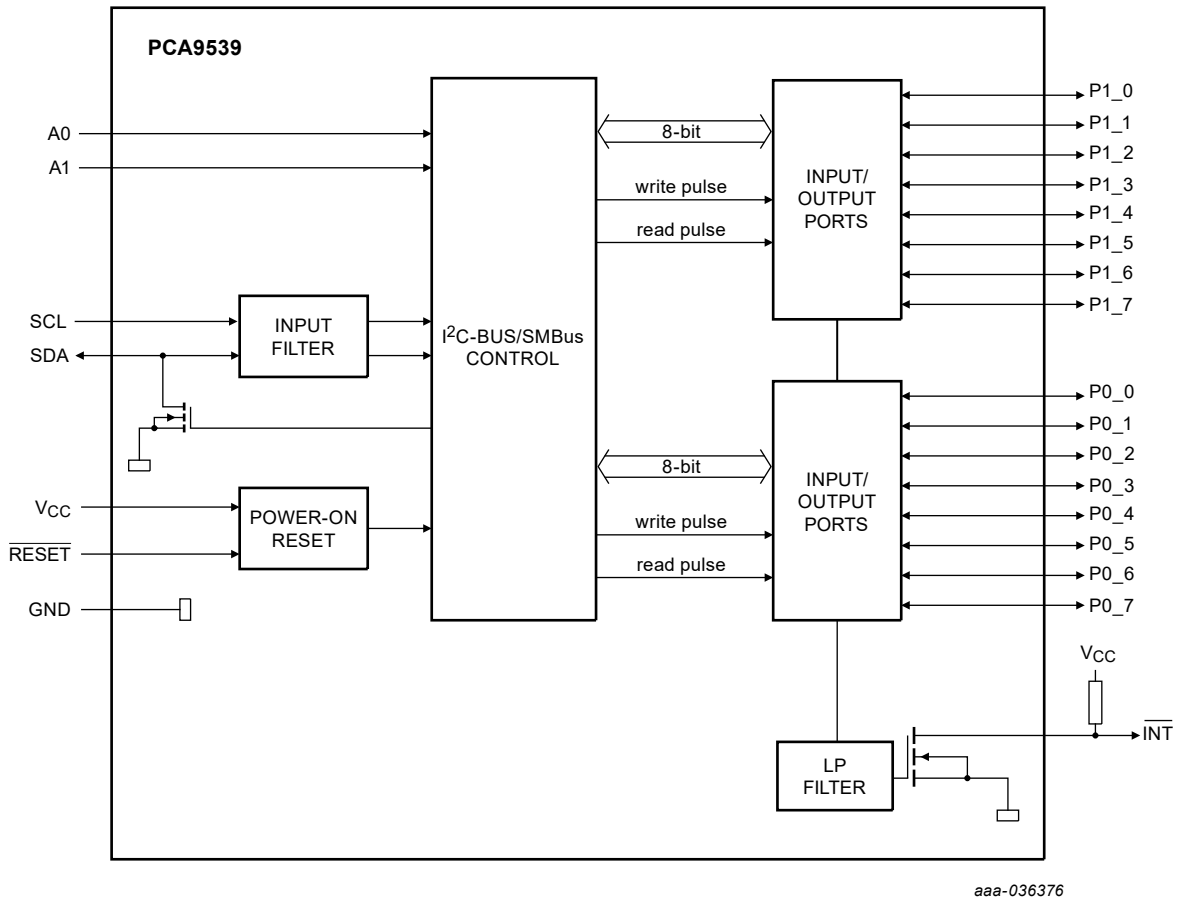
- I²C-bus to parallel port expander
- Operating power supply voltage range of 2.3 V to 5.5 V
- Ultra low standby current consumption:
  - 1 µA (maximum)
- Schmitt-trigger action allows slow input transition and better switching noise immunity at the SCL and SDA inputs
  - V_{hys} = 0.10 × V_{CC} (typical)
  - Noise filter on SCL and SDA inputs
- 5 V tolerant I/Os
- 16 I/O pins which power up configured in input state
- Open-drain active LOW interrupt output ($\overline{INT}$)
- Reset input ($\overline{RESET}$) for resetting PCA9539 to default values
- 400 kHz Fast-mode I²C-bus
- Internal power-on reset
- No glitch on power-up
- Latched outputs with 25 mA drive maximum capability for directly driving LEDs
- Latch-up performance exceeds 100 mA per JESD78, Class II
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- TSSOP24 package: plastic thin shrink small outline package; 24 leads; body width 4.4 mm
- Specified from -40 °C to +85 °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
PCA9539PW	-40 °C to +85 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1

4. Block diagram



Remark: All I/Os are set to inputs at reset.

Fig. 1. Block diagram of PCA9539

5. Pinning information

5.1. Pinning

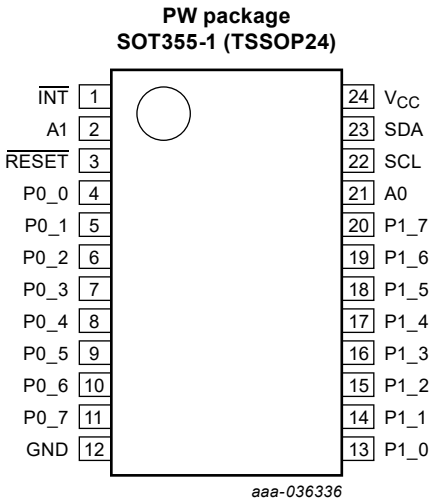


Fig. 2. Pin configuration SOT355-1 (TSSOP24)

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Type	Description
$\overline{INT}$	1	O	Interrupt output. Connect to V_{CC} through a pull-up resistor
A1	2	I	Address input 1. Connect directly to V_{CC} or GND
$\overline{RESET}$	3	I	Active Low reset input. Connect to V_{CC} through a pull-up resistor if no active connection is used.
P0_0 [1]	4	I/O	Parallel port I/O. Push-pull driver. At power on, P0_0 is configured as input
P0_1 [1]	5	I/O	Parallel port I/O. Push-pull driver. At power on, P0_1 is configured as input
P0_2 [1]	6	I/O	Parallel port I/O. Push-pull driver. At power on, P0_2 is configured as input
P0_3 [1]	7	I/O	Parallel port I/O. Push-pull driver. At power on, P0_3 is configured as input
P0_4 [1]	8	I/O	Parallel port I/O. Push-pull driver. At power on, P0_4 is configured as input
P0_5 [1]	9	I/O	Parallel port I/O. Push-pull driver. At power on, P0_5 is configured as input
P0_6 [1]	10	I/O	Parallel port I/O. Push-pull driver. At power on, P0_6 is configured as input
P0_7 [1]	11	I/O	Parallel port I/O. Push-pull driver. At power on, P0_7 is configured as input
GND	12	power	Ground
P1_0 [2]	13	I/O	Parallel port I/O. Push-pull driver. At power on, P1_0 is configured as input
P1_1 [2]	14	I/O	Parallel port I/O. Push-pull driver. At power on, P1_1 is configured as input
P1_2 [2]	15	I/O	Parallel port I/O. Push-pull driver. At power on, P1_2 is configured as input
P1_3 [2]	16	I/O	Parallel port I/O. Push-pull driver. At power on, P1_3 is configured as input
P1_4 [2]	17	I/O	Parallel port I/O. Push-pull driver. At power on, P1_4 is configured as input
P1_5 [2]	18	I/O	Parallel port I/O. Push-pull driver. At power on, P1_5 is configured as input
P1_6 [2]	19	I/O	Parallel port I/O. Push-pull driver. At power on, P1_6 is configured as input
P1_7 [2]	20	I/O	Parallel port I/O. Push-pull driver. At power on, P1_7 is configured as input

Symbol	Pin	Type	Description
A0	21	I	Address input 0. Connect directly to V_{CC} or GND
SCL	22	I	Serial clock bus. Connect to V_{CC} through a pull-up resistor
SDA	23	I/O	Serial data bus. Connect to V_{CC} through a pull-up resistor.
V_{CC}	24	power	Supply voltage.

[1] Pins P0_0 to P0_7 correspond to bits P0.0 to P0.7. At power-up, all I/O are configured as high-impedance inputs.
[2] Pins P1_0 to P1_7 correspond to bits P1.0 to P1.7. At power-up, all I/O are configured as high-impedance inputs.

6. Functional description

For the block diagram of the PCA9539 see Fig. 1.

6.1. Device address

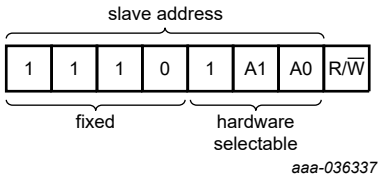


Fig. 3. PCA9539 device address

A1 and A0 are the hardware address package pins and are held to either HIGH (logic 1) or LOW (logic 0) to assign one of the four possible slave addresses. The last bit of the slave address (R/$\overline{W}$) defines the operation (read or write) to be performed. A HIGH (logic 1) selects a read operation, while a LOW (logic 0) selects a write operation.

6.2. Registers

6.2.1. Pointer register and command byte

Following the successful acknowledgement of the address byte, the bus master sends a command byte, which is stored in the address pointer register of the PCA9539. The lower three bits of this data byte state the operation (read or write) and the internal registers (Input, Output, Polarity Inversion, or Configuration) that will be affected. This register is write only.

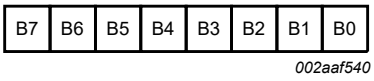


Fig. 4. Pointer register bits

Table 3. Command byte

Pointer register bits								Command byte (hexadecimal)	Register	Protocol	Power-up default
B7	B6	B5	B4	B3	B2	B1	B0				
0	0	0	0	0	0	0	0	00h	Input port 0	read byte	xxxx xxxx [1]
0	0	0	0	0	0	0	1	01h	Input port 1	read byte	xxxx xxxx
0	0	0	0	0	0	1	0	02h	Output port 0	read/write byte	1111 1111
0	0	0	0	0	0	1	1	03h	Output port 1	read/write byte	1111 1111
0	0	0	0	0	1	0	0	04h	Polarity Inversion port 0	read/write byte	0000 0000
0	0	0	0	0	1	0	1	05h	Polarity Inversion port 1	read/write byte	0000 0000
0	0	0	0	0	1	1	0	06h	Configuration port 0	read/write byte	1111 1111
0	0	0	0	0	1	1	1	07h	Configuration port 1	read/write byte	1111 1111

[1] The default value 'X' is determined by the externally applied logic level.

6.2.2. Input port register pair (00h, 01h)

The Input port registers (registers 0 and 1) define the incoming logic levels of the pins, regardless of whether the pin is defined as an input or an output by the Configuration register. The Input port registers are read only; writes to these registers have no effect. The default value 'X' is determined by the externally applied logic level. An Input port register read operation is performed as described in Section 7.2.

Table 4. Input port 0 register (address 00h)

Bit	7	6	5	4	3	2	1	0
Symbol	I0.7	I0.6	I0.5	I0.4	I0.3	I0.2	I0.1	I0.0
Default	X	X	X	X	X	X	X	X

Table 5. Input port 1 register (address 01h)

Bit	7	6	5	4	3	2	1	0
Symbol	I1.7	I1.6	I1.5	I1.4	I1.3	I1.2	I1.1	I1.0
Default	X	X	X	X	X	X	X	X

6.2.3. Output port register pair (02h, 03h)

The Output port registers (registers 2 and 3) define the outgoing logic levels of the pins defined as outputs by the Configuration register. Bit values in these registers have no effect on pins defined as inputs. In turn, reads from these registers reflect the value that was written to these registers, **not** the actual pin value. A register pair write is described in Section 7.1 and a register pair read is described in Section 7.2.

Table 6. Output port 0 register (address 02h)

Bit	7	6	5	4	3	2	1	0
Symbol	O0.7	O0.6	O0.5	O0.4	O0.3	O0.2	O0.1	O0.0
Default	1	1	1	1	1	1	1	1

Table 7. Output port 1 register (address 03h)

Bit	7	6	5	4	3	2	1	0
Symbol	O1.7	O1.6	O1.5	O1.4	O1.3	O1.2	O1.1	O1.0
Default	1	1	1	1	1	1	1	1

6.2.4. Polarity inversion register pair (04h, 05h)

The Polarity inversion registers (registers 4 and 5) allow polarity inversion of pins defined as inputs by the Configuration register. If a bit in these registers is set (written with '1'), the corresponding port pin's polarity is inverted in the Input register. If a bit in this register is cleared (written with a '0'), the corresponding port pin's polarity is retained. A register pair write is described in Section 7.1 and a register pair read is described in Section 7.2.

Table 8. Polarity inversion port 0 register (address 04h)

Bit	7	6	5	4	3	2	1	0
Symbol	N0.7	N0.6	N0.5	N0.4	N0.3	N0.2	N0.1	N0.0
Default	0	0	0	0	0	0	0	0

Table 9. Polarity inversion port 1 register (address 05h)

Bit	7	6	5	4	3	2	1	0
Symbol	N1.7	N1.6	N1.5	N1.4	N1.3	N1.2	N1.1	N1.0
Default	0	0	0	0	0	0	0	0

6.2.5. Configuration register pair (06h, 07h)

The Configuration registers (registers 6 and 7) configure the direction of the I/O pins. If a bit in these registers is set to 1, the corresponding port pin is enabled as a high-impedance input. If a bit in these registers is cleared to 0, the corresponding port pin is enabled as an output. A register pair write is described in Section 7.1 and a register pair read is described in Section 7.2.

Table 10. Configuration port 0 register (address 06h)

Bit	7	6	5	4	3	2	1	0
Symbol	C0.7	C0.6	C0.5	C0.4	C0.3	C0.2	C0.1	C0.0
Default	1	1	1	1	1	1	1	1

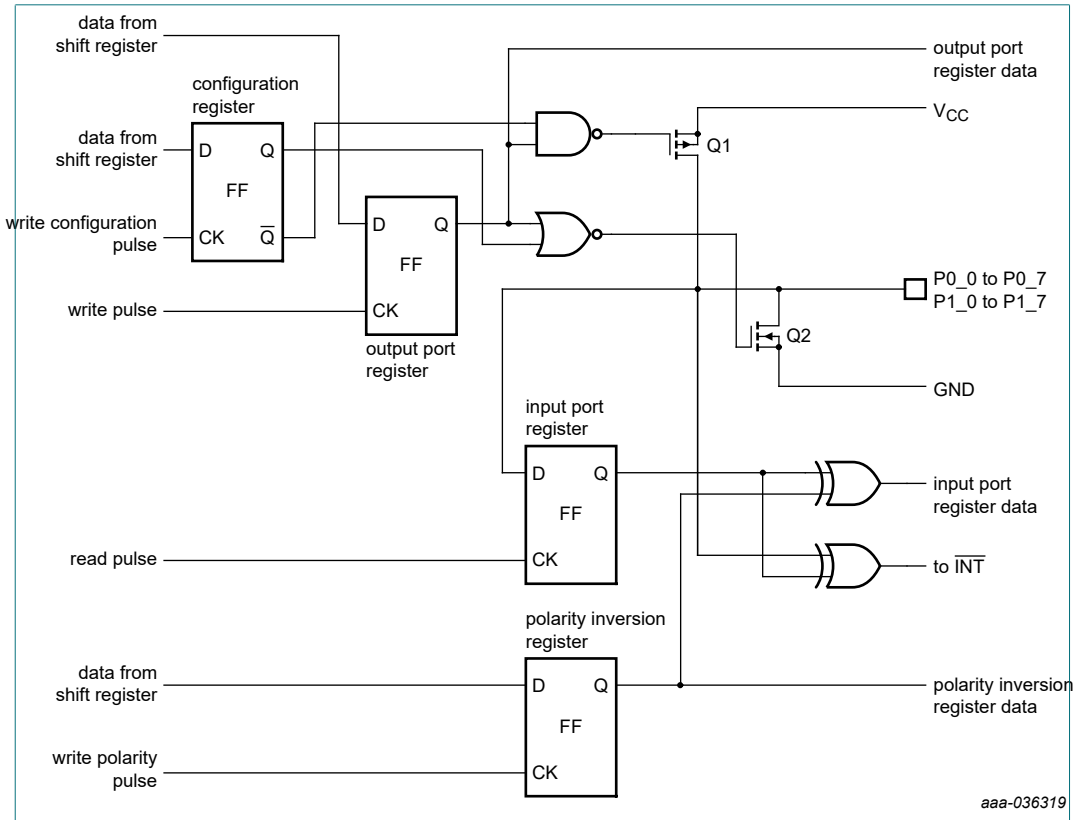
Table 11. Configuration port 1 register (address 07h)

Bit	7	6	5	4	3	2	1	0
Symbol	C1.7	C1.6	C1.5	C1.4	C1.3	C1.2	C1.1	C1.0
Default	1	1	1	1	1	1	1	1

6.3. I/O port

When an I/O is configured as an input, FETs Q1 and Q2 are off, which creates a high-impedance input. The input voltage may be raised above V_{CC} to a maximum of 5.5 V.

If the I/O is configured as an output, Q1 or Q2 is enabled, depending on the state of the Output port register. In this case, there are low-impedance paths between the I/O pin and either V_{CC} or GND. The external voltage applied to this I/O pin should not exceed the recommended levels for proper operation.



Reset using power-on reset or $\overline{\text{RESET}}$, all registers return to default values.

Fig. 5. Simplified schematic of the I/Os (P0_0 to P0_7, P1_0 to P1_7)

6.4. Power-on reset

When power (from 0 V) is applied to V_{CC} and starts rising, an internal power-on reset holds the PCA9539 in a reset condition until V_{CC} has reached V_{PORR}. At that time, the reset condition is released and the PCA9539 registers and I²C-bus/SMBus state machine initializes to their default states. After that, V_{CC} must be lowered to below 0.2 V and back up to the operating voltage for a power-reset cycle. See Section 8.2.

6.5. $\overline{\text{RESET}}$ input

The $\overline{\text{RESET}}$ pin can be used to reset the registers, state machine and IOs to default values. By sending active LOW on this pin, the device enters reset state irrespective of the state of the system. A minimum active low time $t_{w(rst)}$ is required to guarantee the reset functionality. When $\overline{\text{RESET}}$ is HIGH (1), the I/O levels at the ports can be changed externally or through master. $\overline{\text{RESET}}$ input requires a pull up resistor to V_{CC} if there is no active connection.

6.6. Interrupt output

An interrupt is generated by any rising or falling edge of the port inputs in the Input mode. After time $t_{v(INT)}$, the signal $\overline{INT}$ is valid. The interrupt is reset when data on the port changes back to the original value or when data is read form the port that generated the interrupt (see Fig. 9 and Fig. 10). Resetting occurs in the Read mode at the acknowledge (ACK) or not acknowledge (NACK) bit after the rising edge of the SCL signal. Interrupts that occur during the ACK or NACK clock pulse can be lost (or be very short) due to the resetting of the interrupt during this pulse. Any change of the I/Os after resetting is detected and is transmitted as $\overline{INT}$.

A pin configured as an output cannot cause an interrupt. Changing an I/O from an output to an input may cause a false interrupt to occur, if the state of the pin does not match the contents of the Input Port register.

7. Bus transactions

The PCA9539 is an I²C-bus slave device. Data is exchanged between the master and PCA9539 through write and read commands using I²C-bus. The two communication lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

7.1. Writing to the port registers

Data is transmitted to the PCA9539 by sending the start condition, device address and setting the read-write bit to a logic 0 (see Fig. 3). The command byte is sent after the address and determines which register will receive the data following the command byte.

Eight registers within the PCA9539 are configured to operate as four register pairs. The four pairs are input port, output port, polarity inversion, configuration registers. After sending data to one register, the next data byte is sent to the other register in the pair (see Fig. 6 and Fig. 7). For example, if the first byte is sent to Output Port 1 (register 3), the next byte is stored in Output Port 0 (register 2).

There is no limitation on the number of data bytes sent in one write transmission. In this way, the host can continuously update a register pair independently of the other registers, or the host can simply update a single register.

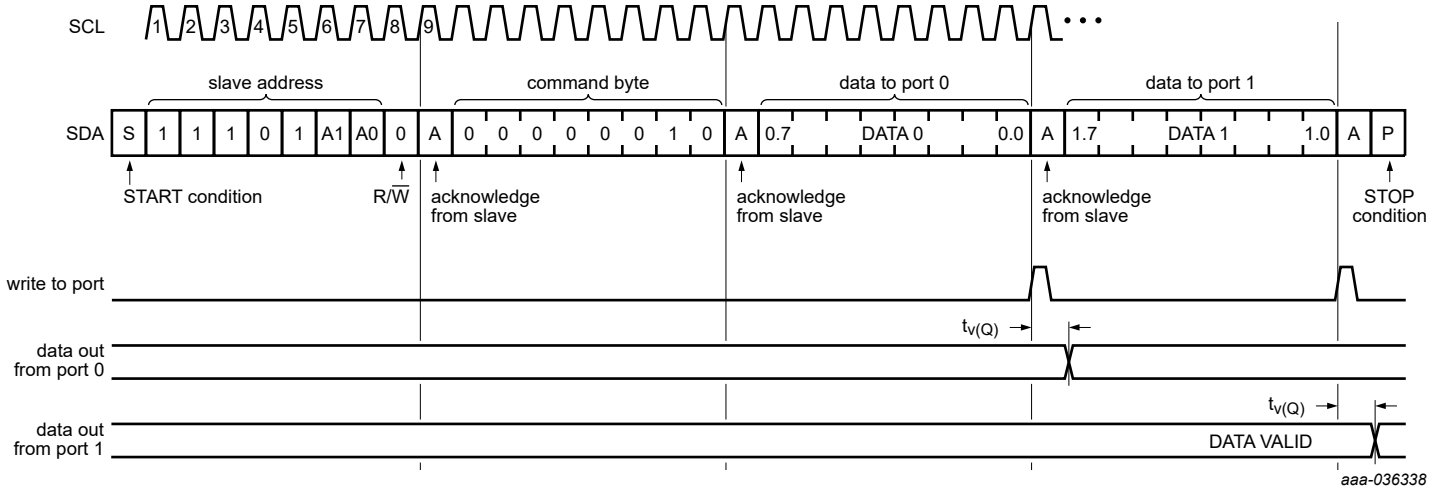


Fig. 6. Write to output port registers

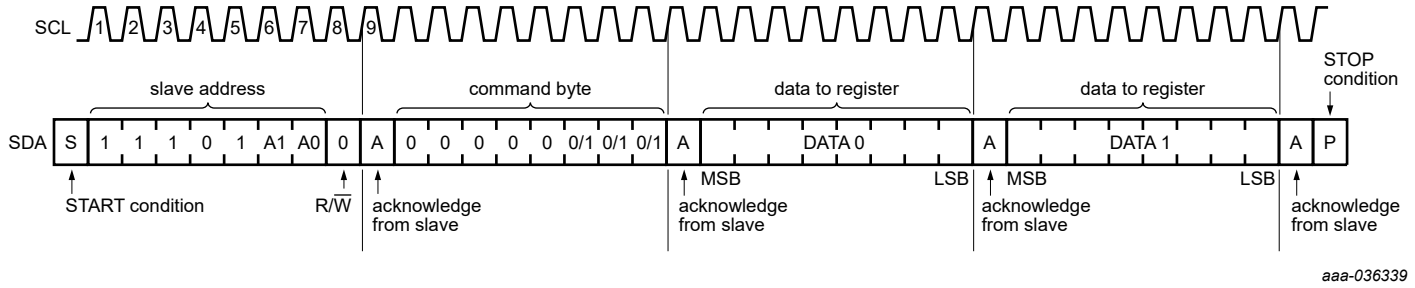
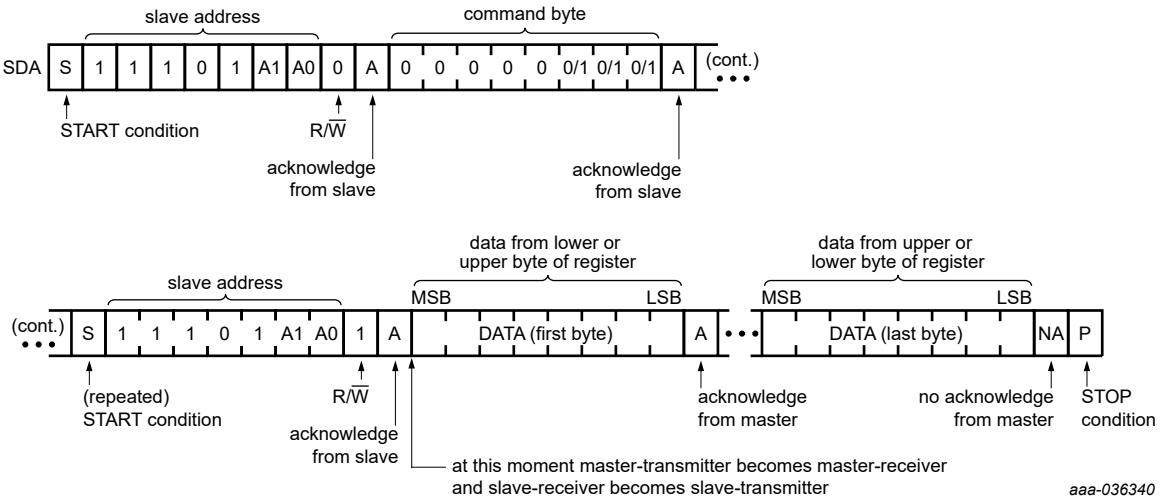


Fig. 7. Write to Control registers

7.2. Reading the port registers

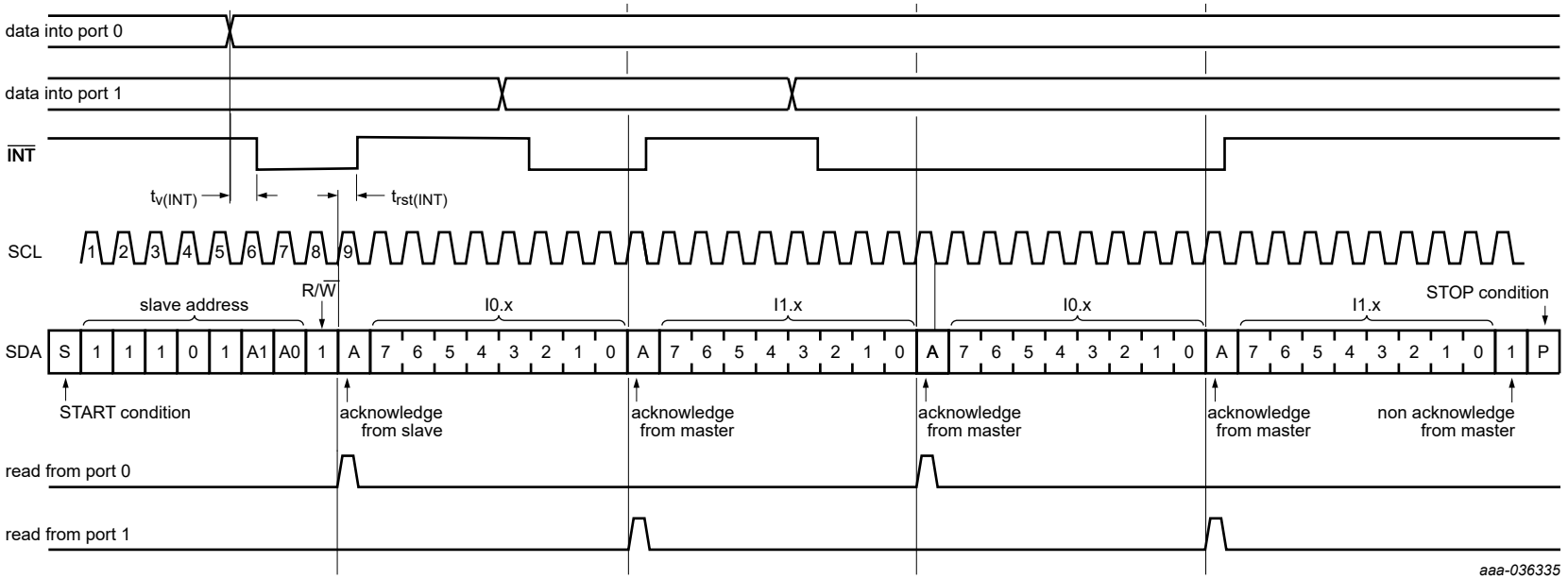
In order to read data from the PCA9539, the bus master must first send the PCA9539 start condition, device address with the read-write bit set to a logic 0 (see Fig. 3). The command byte is sent after the address and determines which register will be accessed. After a start or restart, the device address is sent again, but this time the least significant bit is set to a logic 1. Data from the register defined by the command byte is sent by the PCA9539 (see Fig. 8, Fig. 9 and Fig. 10). Data is clocked into the register on the rising edge of the acknowledge clock pulse. After the first byte is read, additional bytes may be read but the data now reflects the information in the other register in the pair. For example, if Input Port 1 is read, the next byte read is Input Port 0. There is no limit on the number of data bytes received in one read transmission, but on the final byte received the bus master must not acknowledge the data.

After a subsequent start or restart, the command byte contains the value of the next register to be read in the pair. For example, if Input Port 1 was read last before the restart, the register that is read after the restart is the Input Port 0.



Remark: Transfer can be stopped at any time by a STOP condition.

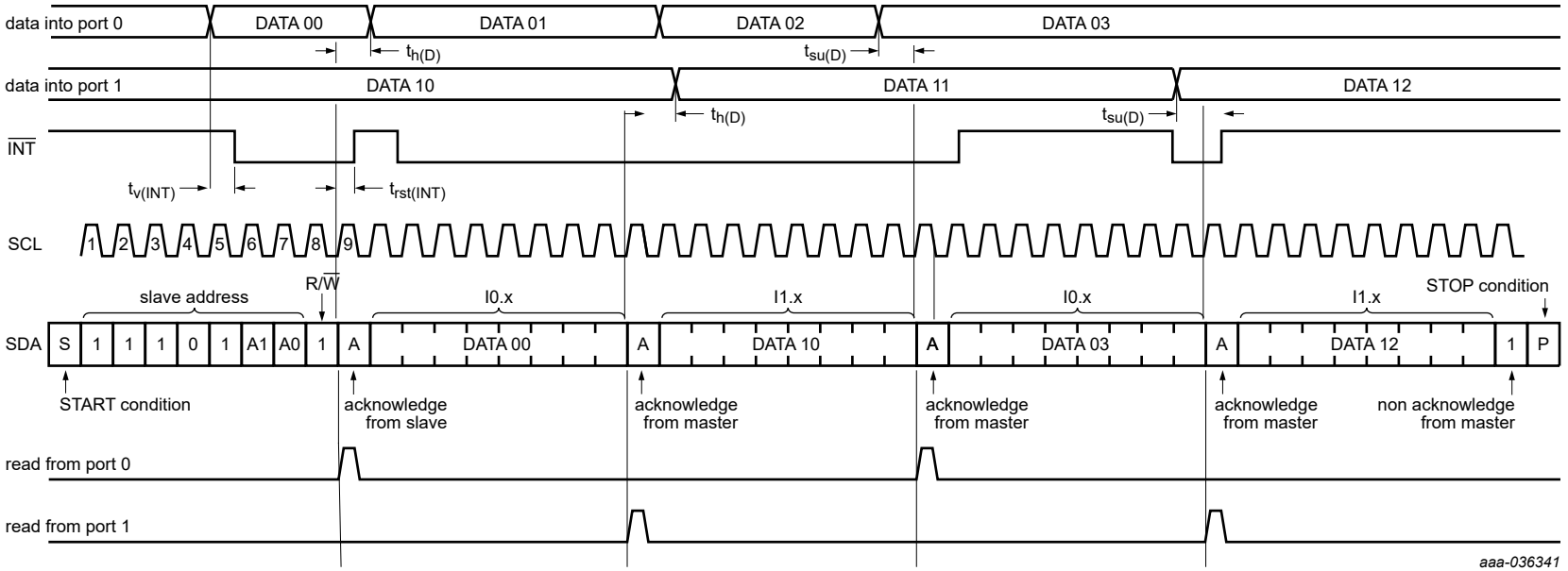
Fig. 8. Read from register



Remark: Transfer of data can be stopped at any moment by a STOP condition. When this occurs, data present at the latest acknowledge phase is valid (output mode). It is assumed that the command byte has previously been set to '00h' (read input port register).

This figure eliminates the command byte transfer and a restart between the initial slave address call and the actual data transfer from P port (see Fig. 8).

Fig. 9. Read input port register, scenario 1

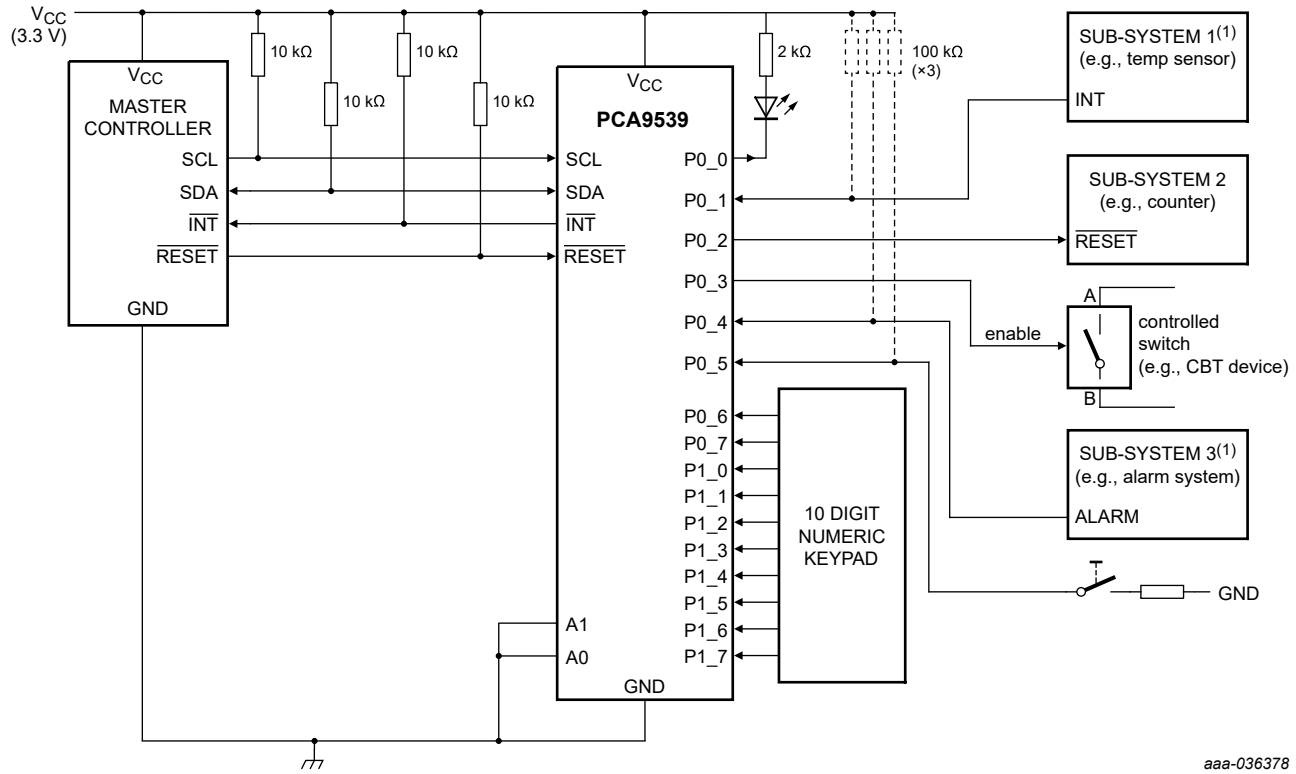


Remark: Transfer of data can be stopped at any moment by a STOP condition. When this occurs, data present at the latest acknowledge phase is valid (output mode). It is assumed that the command byte has previously been set to '00h' (read input port register).

This figure eliminates the command byte transfer and a restart between the initial slave address call and the actual data transfer from P port (see Fig. 8).

Fig. 10. Read input port register, scenario 2

8. Application design-in information



Device address configured as 1110 100X for this example.
P0_0, P0_2, P0_3 configured as outputs.
P0_1, P0_4, P0_5 configured as inputs.
P0_6, P0_7 and (P1_0 to P1_7) configured as inputs.

(1) External pull-up and pull-down resistors are required for inputs IO P ports that may float. If a driver to an input will never let the input float, a resistor is not needed. If an output in the P port is configured as a push-pull output there is no need for external pull-up resistors. If an output in the P port is configured as an open-drain output, external pull-up resistors are required.

Fig. 11. Typical application

8.1. Minimizing I_{CC} when the I/Os are used to control LEDs

When the I/Os are used to control LEDs, they are normally connected to V_{CC} through a resistor as shown in Fig. 11. Since the LED acts as a diode, when the LED is off the I/O V_I is about 1.2 V less than V_{CC}. The supply current, I_{CC}, increases as V_I becomes lower than V_{CC}.

Designs needing to minimize current consumption, such as battery power applications, should consider maintaining the I/O pins greater than or equal to V_{CC} when the LED is off. Fig. 12 shows a high value resistor in parallel with the LED. Fig. 13 shows V_{CC} less than the LED supply voltage by at least 1.2 V. Both of these methods maintain the I/O V_I at or above V_{CC} and prevents additional supply current consumption when the LED is off.

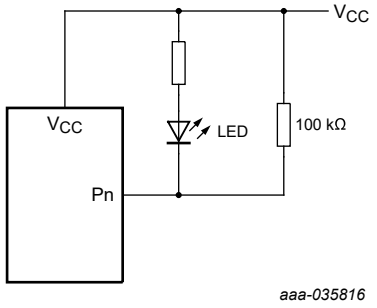


Fig. 12. High value resistor in parallel with the LED

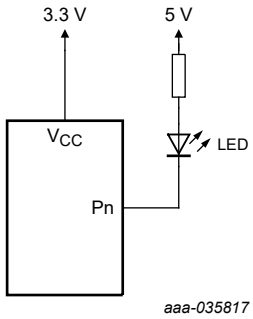


Fig. 13. Device supplied by a lower voltage

8.2. Power-on reset requirements

The device can be properly reset if V_{CC} complies with $t_{d(rst)}$ > 300 ms as shown in Fig. 14. If the ramp conditions and reset delay time are outside the specification, the power-on reset (POR) condition can be missed and device can lock up.

Table 12. Recommended supply sequencing and ramp rates

T_{amb} = 25 °C (unless otherwise noted). Not tested; specified by design.

Symbol	Parameter	Condition	T_{amb} = 25 °C			Unit
			Min	Typ	Max	
$t_{rise(V_{CC})}$	supply ramp-up time	Fig. 14	0.1	-	2000	ms
$t_{fall(V_{CC})}$	supply ramp-down time	Fig. 14	0.1	-	2000	ms
$t_{d(rst)}$	reset delay time	Fig. 14; re-ramp time when V_{CC} drops to GND	300	-	-	ms

Fig. 14 shows supply ramp-up, ramp-down and reset delay time.

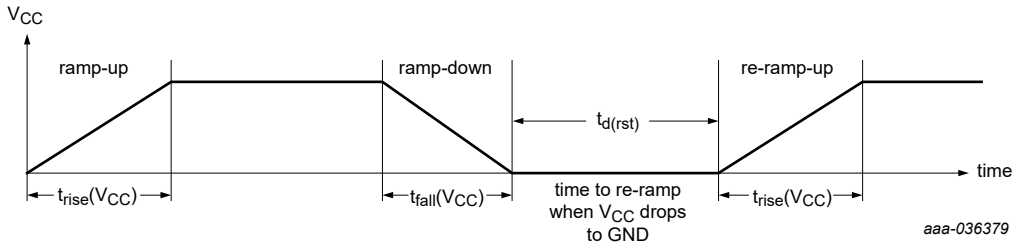


Fig. 14. V_{CC} is lowered to 0 V and then ramped up to V_{CC}

V_{PORR} is the voltage level of V_{CC} at which the reset condition is released and all the registers and the I²C-bus/SMBus state machine are initialized to their default states.

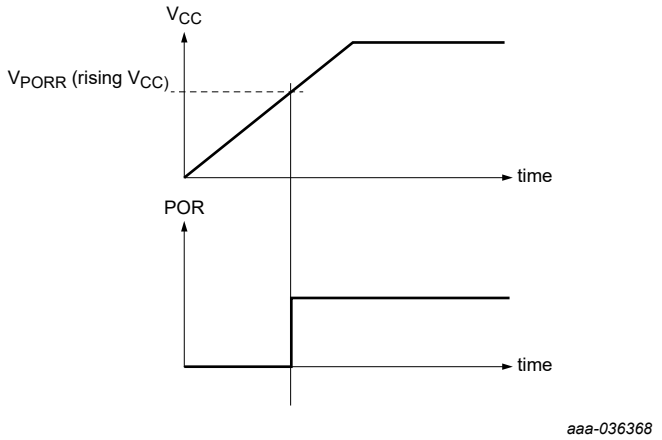


Fig. 15. Power-on reset voltage (V_{POR})

9. Limiting values

Table 13. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	6	V
V_I	input voltage	[1]	-0.5	6	V
V_O	output voltage	[1]	-0.5	6	V
I_{IK}	input clamping current	A0, A1, $\overline{RESET}$, SCL; $V_I < 0$ V	-	-20	mA
I_{OK}	output clamping current	$\overline{INT}$; $V_O < 0$ V	-	-20	mA
I_{IOK}	input/output clamping current	P port; $V_O < 0$ V or $V_O > V_{CC}$	-	±20	mA
		SDA; $V_O < 0$ V	-	-20	mA
I_{OL}	LOW-level output current	continuous; I/O port	-	50	mA
		continuous; SDA, $\overline{INT}$	-	25	mA
I_{OH}	HIGH-level output current	continuous; P port	-	25	mA
I_{CC}	supply current		-	160	mA
I_{GND}	ground supply current		-	250	mA
P_{tot}	total power dissipation		-	200	mW
T_{stg}	storage temperature		-65	+150	°C
$T_{j(max)}$	maximum junction temperature		-	100	°C

[1] The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

10. Recommended operating conditions

Table 14. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		2.3	5.5	V
V_{IH}	HIGH-level input voltage	SCL, SDA	0.7 × V_{CC}	5.5	V
		P1_7 to P0_0	0.7 × V_{CC}	5.5	V
		A0, A1, $\overline{\text{RESET}}$	0.7 × V_{CC}	V_{CC}	V
V_{IL}	LOW-level input voltage	SCL, SDA	-0.5	0.3 × V_{CC}	V
		A0, A1, $\overline{\text{RESET}}$, P1_7 to P0_0	-0.5	0.3 × V_{CC}	V
I_{OH}	HIGH-level output current	P1_7 to P0_0	-	10	mA
I_{OL}	LOW-level output current	P1_7 to P0_0	-	25	mA
T_{amb}	ambient temperature	operating in free air	-40	+85	°C

11. Thermal characteristics

Table 15. Thermal characteristics

Symbol	Parameter	Conditions		Max	Unit
$Z_{th(j-a)}$	transient thermal impedance from junction to ambient	TSSOP24 package	[1]	100	K/W

[1] The package thermal impedance is calculated in accordance with JESD 51-7.

12. Static characteristics

Table 16. Static characteristics

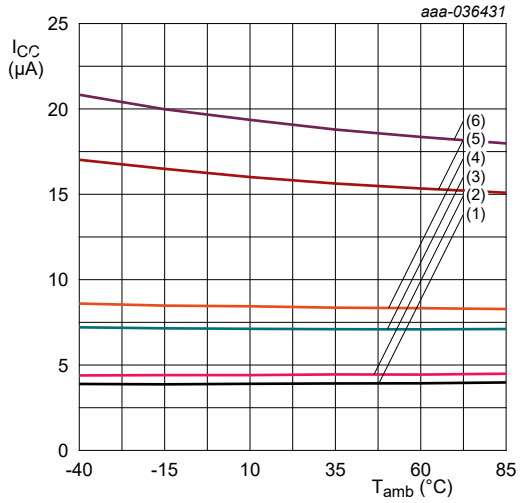
V_{CC} = 2.3 V to 5.5 V; unless otherwise specified.

Symbol	Parameter	Conditions		T_{amb} = -40 °C to +85 °C			Unit
				Min	Typ [1]	Max	
V_{IK}	input clamping voltage	I_I = -18 mA		-1.2	-	-	V
V_{PORR}	power-on reset trip voltage; V_{CC} rising	V_I = V_{CC} or GND; I_O = 0 mA		-	1.25	1.55	V
I_{OL}	LOW-level output current	V_{OL} = 0.4 V; V_{CC} = 2.3 V to 5.5 V					
		SDA		3	-	-	mA
		$\overline{INT}$		3	28 [2]	-	mA
		P port					
		V_{OL} = 0.5 V; V_{CC} = 2.3 V	[3]	8	-	-	mA
		V_{OL} = 0.7 V; V_{CC} = 2.3 V	[3]	10	-	-	mA
		V_{OL} = 0.5 V; V_{CC} = 3.0 V	[3]	8	-	-	mA
		V_{OL} = 0.7 V; V_{CC} = 3.0 V	[3]	10	-	-	mA
		V_{OL} = 0.5 V; V_{CC} = 4.5 V	[3]	8	-	-	mA
		V_{OL} = 0.7 V; V_{CC} = 4.5 V	[3]	10	-	-	mA
V_{OH}	HIGH-level output voltage	P port					
		I_{OH} = -8 mA; V_{CC} = 2.3 V	[4]	2.0	-	-	V
		I_{OH} = -10 mA; V_{CC} = 2.3 V	[4]	1.9	-	-	V
		I_{OH} = -8 mA; V_{CC} = 3.0 V	[4]	2.6	-	-	V
		I_{OH} = -10 mA; V_{CC} = 3.0 V	[4]	2.5	-	-	V
		I_{OH} = -8 mA; V_{CC} = 4.5 V	[4]	4.1	-	-	V
		I_{OH} = -10 mA; V_{CC} = 4.5 V	[4]	4.0	-	-	V
V_{OL}	LOW-level output voltage	P port; I_{OL} = 8 mA					
		V_{CC} = 2.3 V		-	-	0.30	V
		V_{CC} = 3.0 V		-	-	0.25	V
		V_{CC} = 4.5 V		-	-	0.2	V
I_I	input current	V_{CC} = 2.3 V to 5.5 V					
		SCL, SDA; V_I = V_{CC} or GND		-	-	1	µA
		A0, A1, $\overline{RESET}$; V_I = V_{CC} or GND		-	-	±1	µA
I_{IH}	HIGH-level input current	P port; V_I = V_{CC}; V_{CC} = 2.3 V to 5.5 V		-	-	1	µA
I_{IL}	LOW-level input current	P port; V_I = GND; V_{CC} = 2.3 V to 5.5 V		-	-	-1	µA

Symbol	Parameter	Conditions	T_{amb} = -40 °C to +85 °C			Unit
			Min	Typ [1]	Max	
I_{CC}	supply current	SDA, P port, A0, A1, $\overline{RESET}$; V_I on SDA = V_{CC} or GND; V_I on P port and A0, A1, $\overline{RESET}$ = V_{CC}; I_O = 0 mA; I/O = inputs; f_{SCL} = 400 kHz (t_r = 30 ns)				
		V_{CC} = 3.6 V to 5.5 V	-	13	28	µA
		V_{CC} = 2.3 V to 3.6 V	-	6.4	11	µA
		SCL, SDA, P port, A0, A1, $\overline{RESET}$; V_I on SCL, SDA = V_{CC} or GND; V_I on P port and A0, A1, $\overline{RESET}$ = V_{CC}; I_O = 0 mA; I/O = inputs; f_{SCL} = 0 kHz				
		V_{CC} = 2.3 V to 5.5 V	-	-	1	µA
		Active mode; P port, A0, A1, $\overline{RESET}$; V_I on P port, A0, A1, $\overline{RESET}$ = V_{CC}; I_O = 0 mA; I/O = inputs; f_{SCL} = 400 kHz (t_r = 30 ns), continuous register read				
		V_{CC} = 3.6 V to 5.5 V	-	15	55	µA
		V_{CC} = 2.3 V to 3.6 V	-	7.4	22	µA
ΔI_{CC}	additional quiescent supply current	SCL, SDA; one input at V_{CC} - 0.6 V, other inputs at V_{CC} or GND; V_{CC} = 2.3 V to 5.5 V	-	-	4.5	µA
		P port, A0, A1, $\overline{RESET}$; one input at V_{CC} - 0.6 V, other inputs at V_{CC} or GND; V_{CC} = 2.3 V to 5.5 V	-	-	13	µA
C_i	input capacitance	V_I = V_{CC} or GND; V_{CC} = 2.3 V to 5.5 V	-	1.5	2.5	pF
C_{io}	input/output capacitance	$V_{I/O}$ = V_{CC} or GND; V_D = 2.3 V to 5.5 V	-	3	4.5	pF

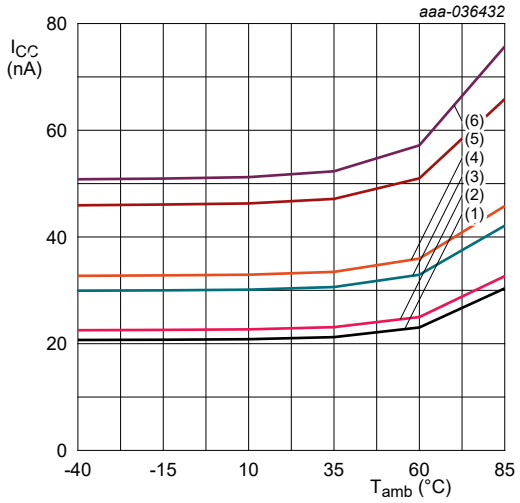
[1] For I_{CC}, all typical values are at nominal supply voltage (3.3 V or 5 V V_{CC}) and T_{amb} = 25 °C. Except for I_{CC}, the typical values are at V_{CC} = 3.3 V and T_{amb} = 25 °C.
[2] Typical value for T_{amb} = 25 °C. V_{OL} = 0.4 V and V_{CC} = 3.3 V.
[3] Each I/O must be externally limited to a maximum of 25 mA and the device must be limited to a maximum current of 200 mA.
[4] The total current sourced by all I/Os must be limited to 160 mA.

12.1. Typical characteristics



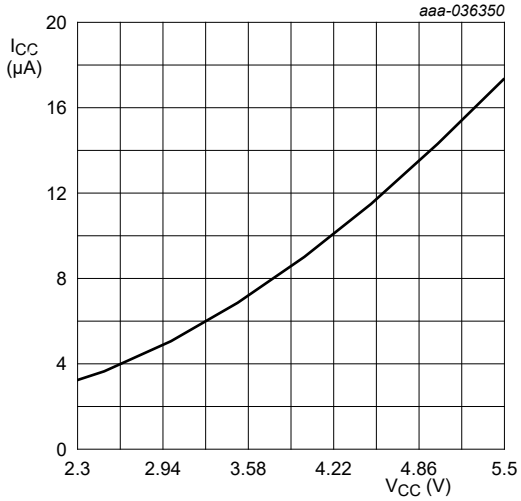
f_{SCL} = 400 kHz
(1) V_{CC} = 2.3 V
(2) V_{CC} = 2.5 V
(3) V_{CC} = 3.3 V
(4) V_{CC} = 3.6 V
(5) V_{CC} = 5.0 V
(6) V_{CC} = 5.5 V

Fig. 16. Supply current versus ambient temperature



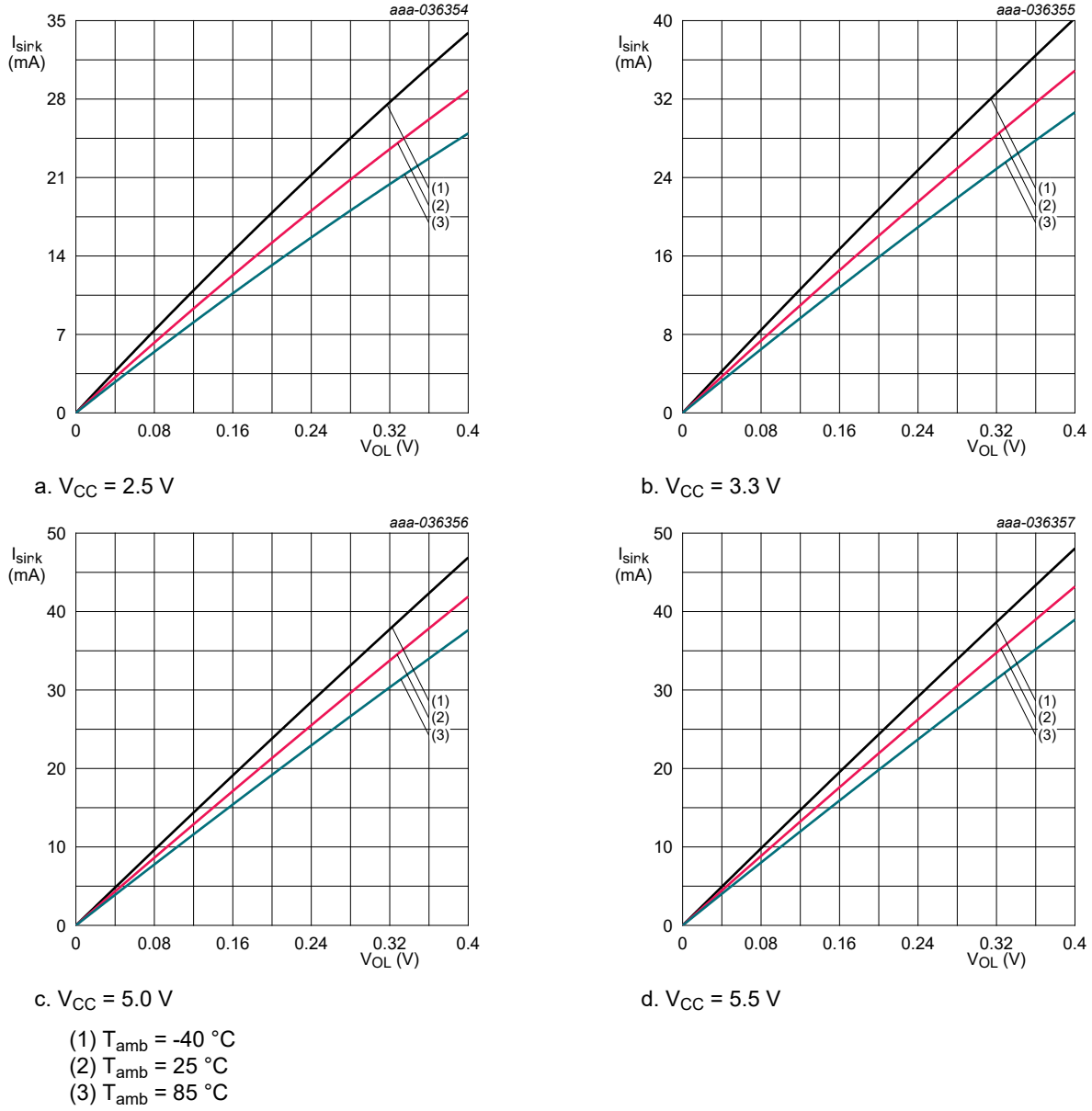
(1) V_{CC} = 2.3 V
(2) V_{CC} = 2.5 V
(3) V_{CC} = 3.3 V
(4) V_{CC} = 3.6 V
(5) V_{CC} = 5.0 V
(6) V_{CC} = 5.5 V

Fig. 17. Standby supply current versus ambient temperature



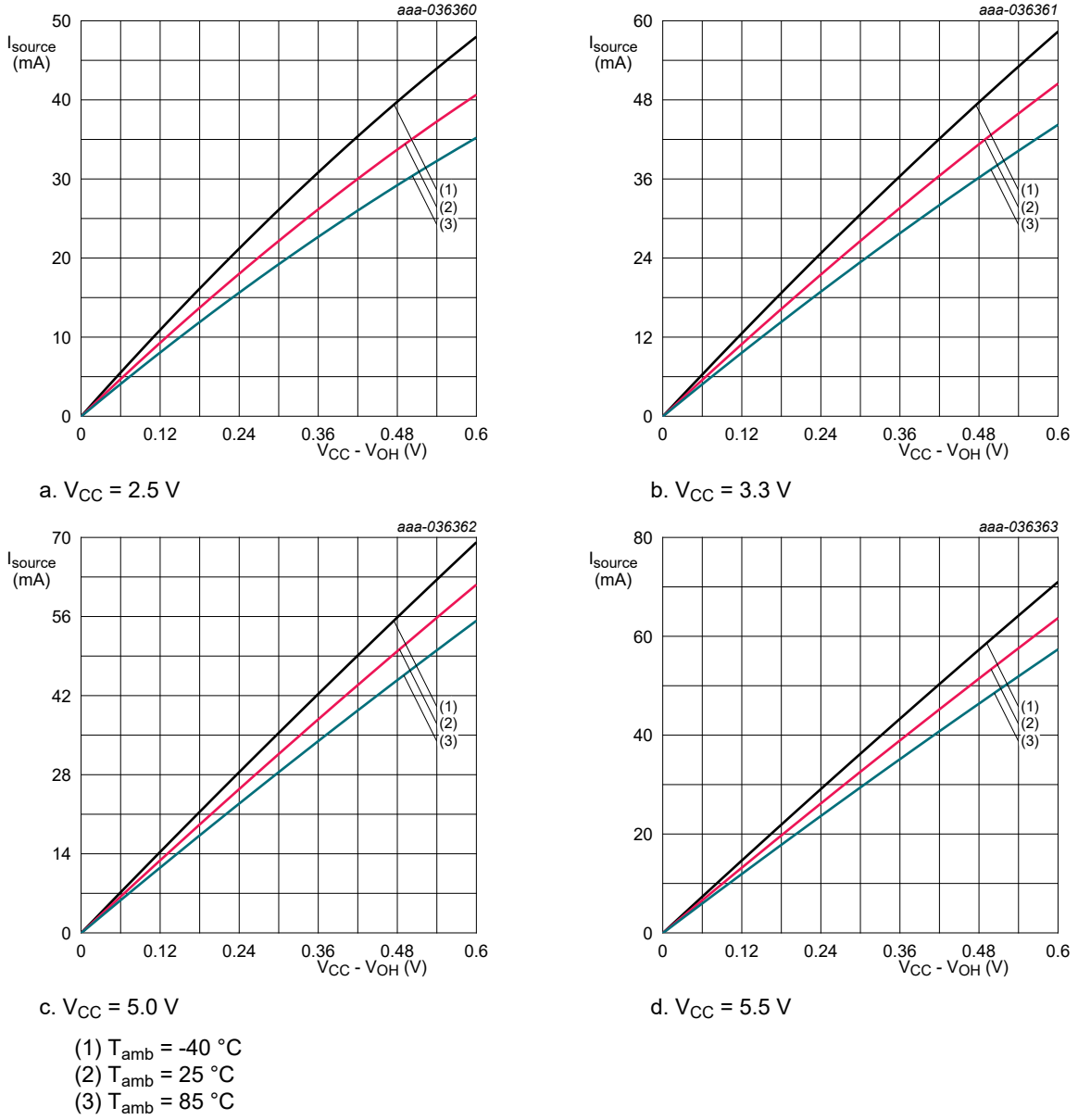
T_{amb} = 25 °C; f_{SCL} = 400 kHz

Fig. 18. Supply current versus supply voltage



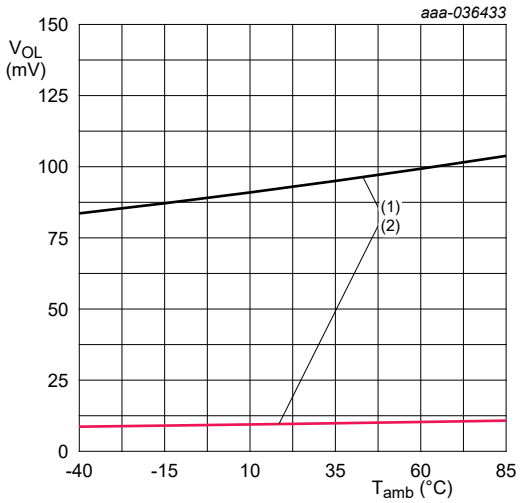
(1) T_{amb} = -40 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = 85 °C

Fig. 19. I/O sink current versus LOW-level output voltage



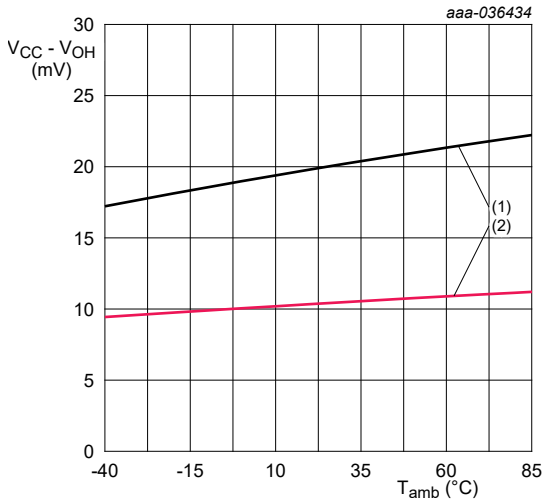
(1) T_{amb} = -40 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = 85 °C

Fig. 20. I/O source current versus HIGH-level output voltage



(1) V_{CC} = 5 V; I_{sink} = 10 mA
(2) V_{CC} = 5 V; I_{sink} = 1 mA

Fig. 21. LOW-level output voltage versus temperature



(1) V_{CC} = 5 V; I_{source} = -10 mA
(2) V_{CC} = 5 V; I_{source} = -1 mA

Fig. 22. I/O high voltage versus temperature

13. Dynamic characteristics

Table 17. I²C-bus interface timing requirements

Over recommended operating free air temperature range, unless otherwise specified. See Fig. 23.

Symbol	Parameter	Conditions	Standard-mode I²C-bus		Fast-mode I²C-bus		Unit
			Min	Max	Min	Max	
f_{SCL}	SCL clock frequency		0	100	0	400	kHz
t_{HIGH}	HIGH period of the SCL clock		4	-	0.6	-	µs
t_{LOW}	LOW period of the SCL clock		4.7	-	1.3	-	µs
t_{SP}	pulse width of spikes that must be suppressed by the input filter		0	50	0	50	ns
$t_{SU;DAT}$	data set-up time		250	-	100	-	ns
$t_{HD;DAT}$	data hold time		0	-	0	-	ns
t_r	rise time of both SDA and SCL signals		-	1000	20	300	ns
t_f	fall time of both SDA and SCL signals		-	300	20x(V_{CC}/5.5 V)	300	ns
t_{BUF}	bus free time between a STOP and START condition		4.7	-	1.3	-	µs
$t_{SU;STA}$	set-up time for a repeated START condition		4.7	-	0.6	-	µs
$t_{HD;STA}$	hold time (repeated) START condition		4	-	0.6	-	µs
$t_{SU;STO}$	set-up time for STOP condition		4	-	0.6	-	µs
$t_{VD;DAT}$	data valid time	SCL LOW to SDA output valid	-	3.45	-	0.9	µs
$t_{VD;ACK}$	data valid acknowledge time	ACK signal from SCL LOW to SDA (out) LOW	-	3.45	-	0.9	µs

Table 18. Reset timing requirements

Over recommended operating free air temperature range; $C_L \leq 100$ pF; unless otherwise specified. See Fig. 26.

Symbol	Parameter	Conditions	Standard-mode I²C-bus		Fast-mode I²C-bus		Unit
			Min	Max	Min	Max	
$t_{w(rst)}$	reset pulse width		6	-	6	-	ns
$t_{rec(rst)}$	reset recovery time		0	-	0	-	ns
t_{rst}	reset time	[1]	550	-	550	-	ns

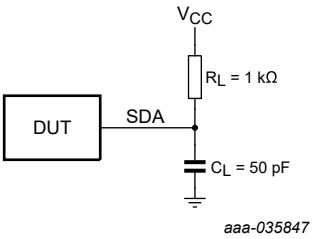
[1] Minimum time for SDA to become HIGH or minimum time to wait before doing a START.

Table 19. Switching characteristics

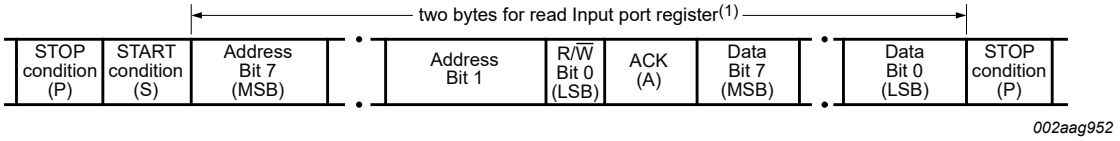
Over recommended operating free air temperature range; $C_L \leq 100$ pF; unless otherwise specified. See Fig. 24 and Fig. 25.

Symbol	Parameter	Conditions	Standard-mode I²C-bus		Fast-mode I²C-bus		Unit
			Min	Max	Min	Max	
$t_{v(INT)}$	valid time on pin $\overline{INT}$	from P port to $\overline{INT}$	-	1	-	1	µs
$t_{rst(INT)}$	reset time on pin $\overline{INT}$	from SCL to $\overline{INT}$	-	1	-	1	µs
$t_{v(Q)}$	data output valid time	from SCL to P port	-	185	-	185	ns
$t_{su(D)}$	data input set-up time	from P port to SCL	-50	-	-50	-	ns
$t_{h(D)}$	data input hold time	from P port to SCL	240	-	240	-	ns

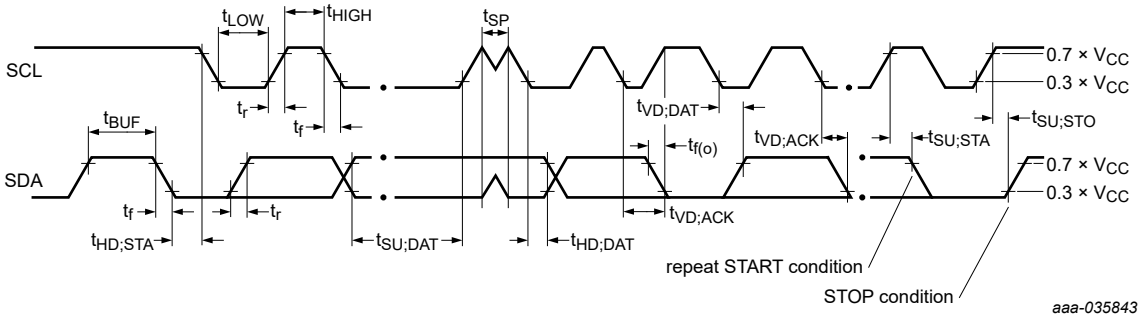
14. Parameter measurement information



a. SDA load configuration



b. Transaction format

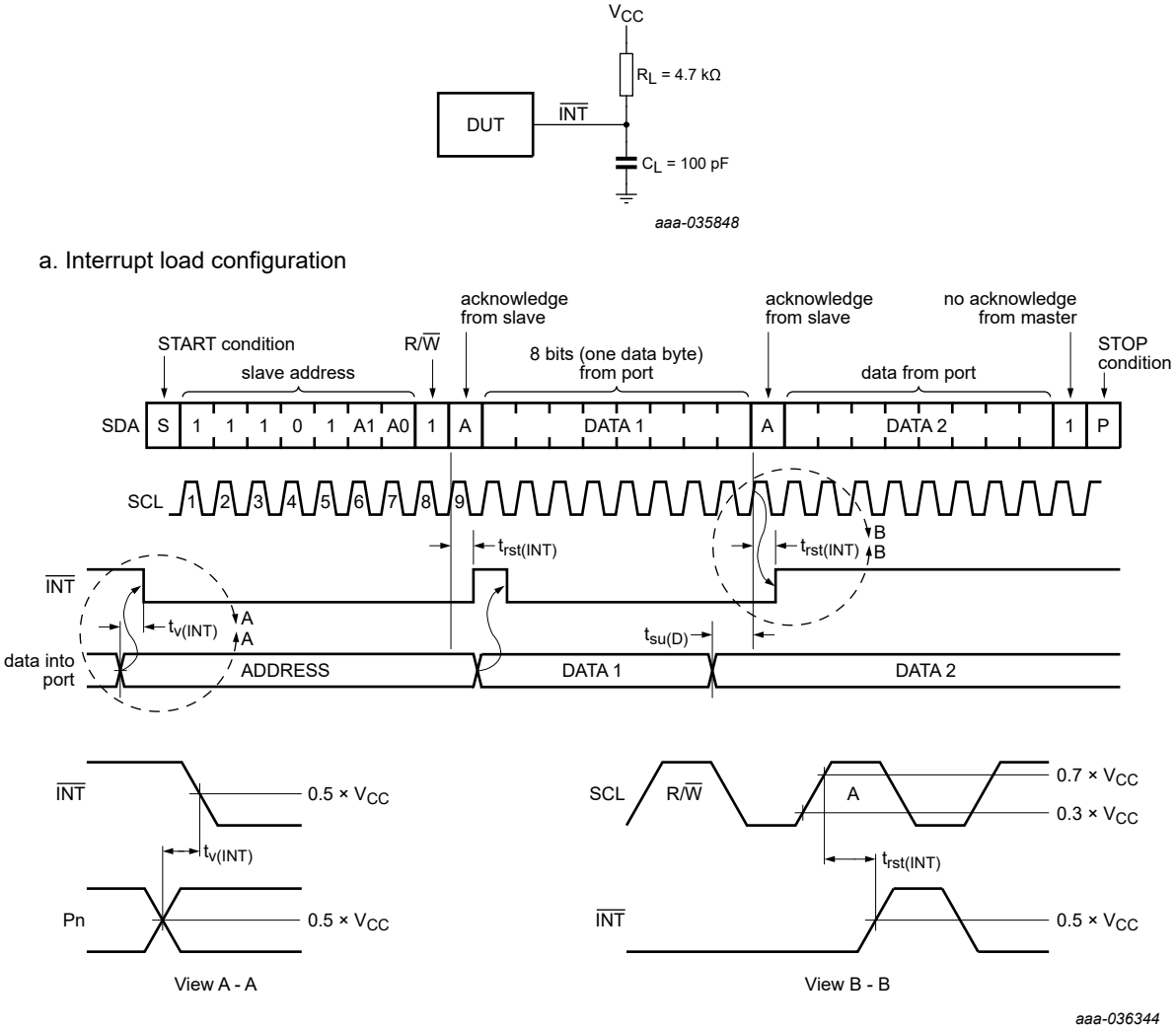


c. Voltage waveforms

C_L includes probe and jig capacitance.
All inputs are supplied by generators having the following characteristics: PRR ≤ 10 MHz; Z_o = 50 Ω; t_r/t_f ≤ 30 ns.
All parameters and waveforms are not applicable to all devices.
Byte 1 = I²C-bus address; Byte 2, byte 3 = P port data.

(1) See Fig. 8.

Fig. 23. I²C-bus interface load circuit and voltage waveforms



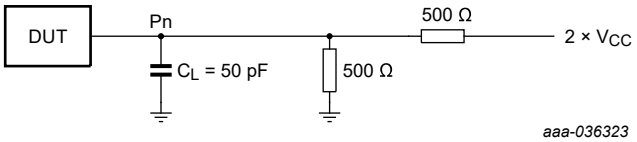
b. Voltage waveforms

C_L includes probe and jig capacitance.

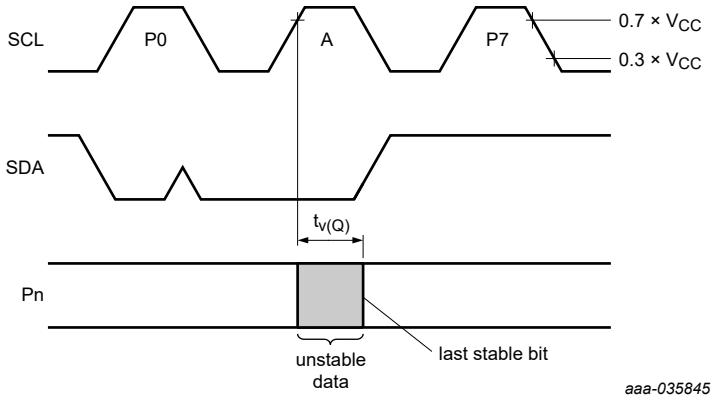
All inputs are supplied by generators having the following characteristics: PRR ≤ 10 MHz; Z_o = 50 Ω; t_r/t_f ≤ 30 ns.

All parameters and waveforms are not applicable to all devices.

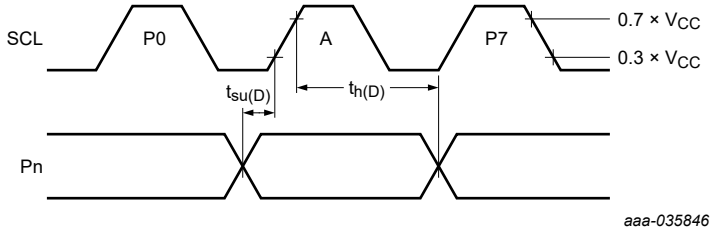
Fig. 24. Interrupt load circuit and voltage waveforms



a. P port load configuration



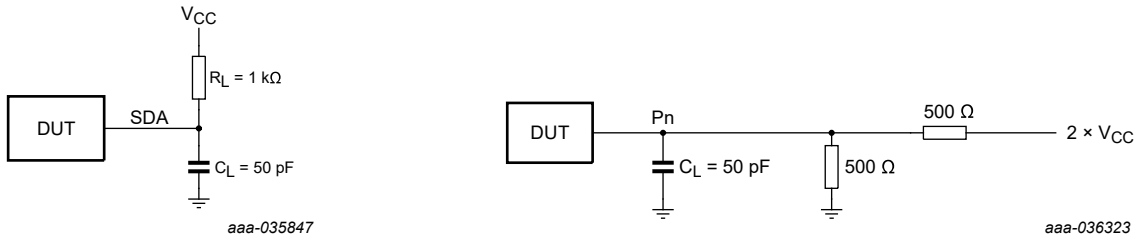
b. Write mode (R/$\overline{W}$ = 0)



c. Read mode (R/$\overline{W}$ = 1)

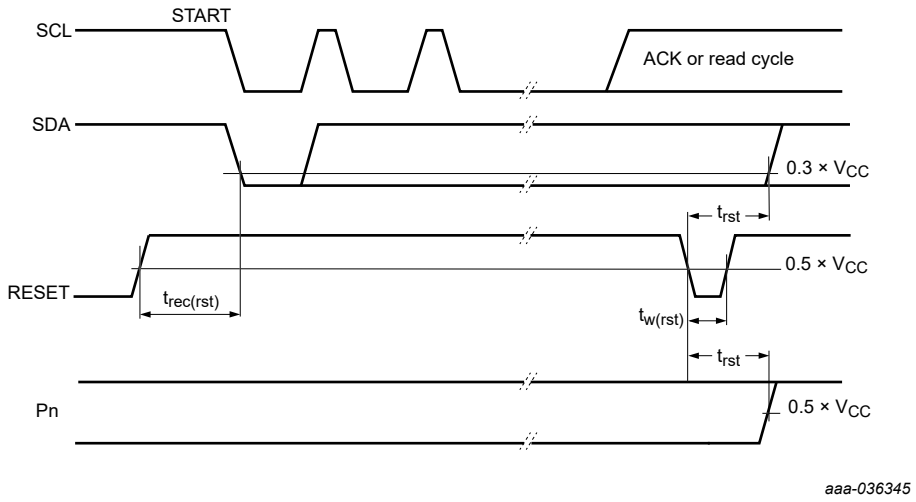
C_L includes probe and jig capacitance.
$t_{v(Q)}$ is measured from 0.7 × V_{CC} on SCL to 50 % I/O (Pn) output.
All inputs are supplied by generators having the following characteristics: PRR ≤ 10 MHz; Z_o = 50 Ω; t_r/t_f ≤ 30 ns.
The outputs are measured one at a time, with one transition per measurement.
All parameters and waveforms are not applicable to all devices.

Fig. 25. P port load circuit and voltage waveforms



a. SDA load configuration

b. P port load configuration



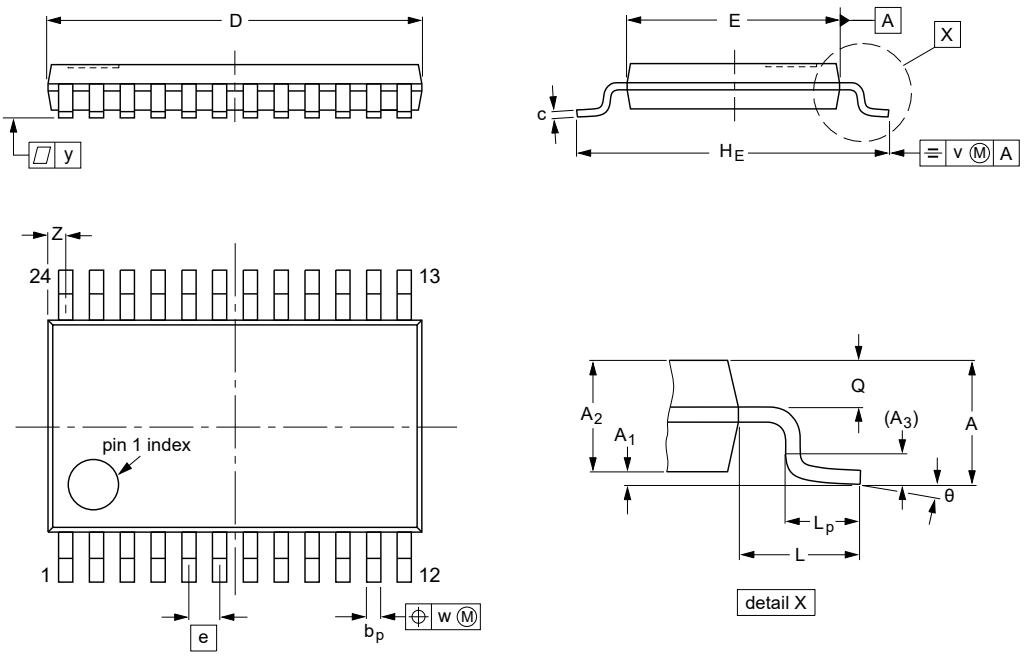
c. $\overline{\text{RESET}}$ timing:

C_L includes probe and jig capacitance.
All inputs are supplied by generators having the following characteristics: PRR ≤ 10 MHz; Z_o = 50 Ω; t_r/t_f ≤ 30 ns.
The outputs are measured one at a time, with one transition per measurement.
I/Os are configured as inputs.
All parameters and waveforms are not applicable to all devices.

Fig. 26. Reset load circuits and voltage waveforms

15. Package outline

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm **SOT355-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(2)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT355-1		MO-153				~~99-12-27~~ 03-02-19

Fig. 27. Package outline SOT355-1 (TSSOP24)

16. Abbreviations

Table 20. Abbreviations

Acronym	Description
ACPI	Advanced Configuration and Power Interface
ANSI	American National Standards Institute
CBT	Cross-Bar Technology
CDM	Charged-Device Model
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
FET	Field-Effect Transistor
FF	Flip-Flop
GPIO	General Purpose Input/Output
HBM	Human Body Model
I²C-bus	Inter-Integrated Circuit bus
I/O	Input/Output
JEDEC	Joint Electron Device Engineering Council
LED	Light-Emitting Diode
SMBus	System Management Bus

17. Revision history

Table 21. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCA9539 v.1.1	20240801	Product data sheet	-	PCA9539 v.1
PCA9539 v.1	20230425	Product data sheet	-	-

18. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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